Atomistic Modeling of Arsenic Diffusion and Activation

Scott T. Dunham*, Pavel Fastenko*, Zudian Qin*, and Graeme Henkelman**

* Dept. of Electrical Engineering, University of Washington
Box 352500, Seattle, WA 98195, dunham@ee.washington.edu
** Dept. of Chemistry, University of Washington

ABSTRACT

Understanding the diffusion and activation of arsenic is critical for the formation of low resistance ultra-shallow junctions as required for nanoscale MOS devices. In this work, we combine the results of ab-initio calculations with continuum and kinetic lattice Monte Carlo (KLMC) simulations in order to gain insight into the fundamental processes involved in arsenic diffusion and activation/deactivation. By including both interstitial and vacancy-mediated diffusion processes, we find it is possible to account for both the very rapid initial deactivation of arsenic as well as the strongly superlinear dependence of interstitial supersaturation on doping level which accompanies deactivation. The critical process is the rearrangement of As atoms via diffusion leading to ejection of silicon atoms from arsenic clusters which are favorable for vacancy incorporation.

Keywords: arsenic, diffusion, activation, lattice Monte Carlo.

1 INTRODUCTION

There is a strong attractive interaction between arsenic and vacancies due to the combination of strain compensation and valence. As a result, under most conditions deactivation of arsenic occurs primarily via the formation of arsenic vacancy complexes. Ab-initio calculations [1], [2] find that As₄V complexes (4 substitutional As atoms surrounding an empty lattice site) are the most energetically favorable, which seems reasonable given that this configuration allows each valence 5 As to have 3 nearest neighbors. It has been observed experimentally [3] that for high active arsenic concentrations, initial deactivation is very rapid (within 15 seconds at 750°C). As also shows strong deactivation for temperatures as low as 400°C [4].

It has been observed that deactivation of high concentration arsenic layer injects interstitials into the substrate [5]. It was proposed, based on XSW (X-ray standing waves) [6] and positron annihilation spectroscopy (PAS) experiments [7] that several second nearest neighbor As atoms (two or more) may kick-out adjacent Si atom, forming an arsenic-vacancy cluster and a self-interstitial. Ab-initio calculations suggest [8] that energetically the most favorable reaction is: As₄Si → As₄V + I. The strong binding energy between arsenic atoms and a vacancies dramatically reduces the energy associated with Frenkel pair formation at sites surrounded by arsenic.

We have investigated these processes via ab-initio, KLMC and continuum simulations. By including both interstitial and vacancy-mediated diffusion processes, we find it is possible to account for both the very rapid initial deactivation of arsenic as well as the strongly superlinear dependence of interstitial supersaturation on doping level. The critical process is the rearrangement of As atoms via diffusion leading to interstitial ejection from arsenic clusters which are favorable for vacancy incorporation.

2 MODELING

2.1 Ab-Initio Calculations

The energy barriers for ejection of a silicon atom from an As₄ tetrahedral cluster was calculated via density functional theory (DFT). The initial state for the process consisted of a 64 atom silicon lattice in which four silicon atoms were replaced with arsenic atoms. The As₄ cluster forms a tetrahedron with a silicon atom at the center of the cluster. The arsenic atoms are thought to be electronically active in this configuration [1]. During the deactivation process the central silicon atom is ejected from the cluster, becoming an interstitial (I) and leaving behind a vacancy (V). A final state was chosen with the interstitial silicon atom as far from the deactivated As₄V cluster as possible in a hexagonal interstitial site. The minimum energy path for the process was calculated with the nudged elastic band (NEB) [10] method in which 8 images were used to connect the initial and final states. The DFT calculations were done with the VASP [11] code using the PW91 functional [12] and ultrasoft pseudopotentials [13]. Plane waves up to a 200 eV energy cutoff were used to represent the wavefunction in the unit cell. The calculations were done with eight points in the k-point mesh.

The results of the NEB calculation are shown in Fig. 1. There is a small initial barrier of 0.2 eV in which the silicon atom moves from the center of the As₄ tetrahedron (a) to a stable site at the center of one of the
tetrahedron faces (b) (e.g., in the center of the triangle formed by 3 of the 4 As atoms, which have relaxed apart). The dimer method [14] was used to search for low energy saddle points leading from the initial state. Five independent dimer searches found the process to (b) to have the lowest barrier. From (b) to (c) the mobile silicon atom continues in the same direction away from the cluster through a tetrahedral site to a hexagonal interstitial site over a barrier of 1.4 eV. At this point the arsenic cluster is thought to be inactive as the interstitial silicon atom is removed from the cluster. This is supported by the final process in which the interstitial silicon atom diffuses to another slightly lower energy hexagonal site (d) because the barrier of 0.3 eV is nearly the same as the bulk hexagonal-tetrahedral-hexagonal diffusion barrier. The overall process is particularly interesting because the presence of the arsenic atoms allow for the creation of an interstitial vacancy pair with a barrier of 1.4 eV which is much less than the Frankel pair formation DFT barrier of 7 eV. Because there does not appear to be any barrier higher than the normal interstitial diffusion barrier, we consider the reverse process to be diffusion limited in the continuum simulations described below.

### 2.2 Kinetic Lattice Monte Carlo

Kinetic lattice Monte Carlo (KLMC) simulations are used in this work to retain the underlying atomic structure and mechanisms and yet also consider system sizes and process times appropriate to submicron device fabrication. The strength of KLMC is that at the fundamental level, most processes involve jumps between locally stable configurations. Thus, the underlying time scale is the hop frequency (~ $10^{-8}$s) rather than the vibration frequency (~ $10^{-13}$s). In addition, by considering only the behavior of mobile species (e.g., point defects), the number of active sites is many order of magnitudes smaller than the lattice density. We use *ab-initio* calculations (both from within our own group as well as outside results) in order to provide parameters for energy versus configuration and transition rates needed for the KLMC simulations. Both *ab-initio* and KLMC results are used to develop continuum models for full process simulation.

We begin by considering vacancy-mediated arsenic diffusion. In previous work [15], we used KLMC simulations to accurately predict the large increase in donor diffusivity in the presence of high donor concentrations observed experimentally (Larsen et al. [16]). This effect is due to interactions of vacancies with multiple dopants simultaneously, which leads to a large increase in arsenic/vacancy pair diffusion. In contrast to our results, List et al. [17] found that arsenic diffusivity actually decreased at high doping levels. This discrepancy arises because at short times arsenic diffusion is greatly enhanced for concentrations above $10^{20}$cm$^{-3}$, while at longer times the diffusivity drops sharply in these same samples [18]. The reason for the sharp drop is the formation of relatively immobile As$_3$V complexes in the more heavily doped samples. In our initial work [15], we used the initial constant diffusivity region as the basis for the extracted diffusivity, while List et al. [17] used a relatively long fixed time, observing the opposite behavior. Based on this analysis, we include both high concentration enhanced diffusion and clustering in our continuum simulations.

Rapid arsenic deactivation via As/V cluster formation requires vacancy formation as diffusion from the surface is much too slow to account for deactivation kinetics at short times and low temperatures as described above. We used KLMC simulations to explore the formation of As clusters which are favorable for enhanced Frenkel pair generation via kick-out of central silicon atom. We find that these structures arise naturally via interstitial-mediated diffusion of As which is enhanced by the same Si kick-out process.

### 2.3 Continuum

To simulate arsenic deactivation we used discrete arsenic-vacancy clusters, assumed to be neutral [1]: (As$_2$V)$^0$, (As$_3$V)$^0$, and (As$_4$V)$^0$. Since clustering involves reactions of point defects and defect-dopant pairs of different charge, it is necessary to include charge transfer reactions, and simulate all possible pathways of clustering reaction. The binding energies of reactions were fitted to equilibrium activation levels from experimental data [9], [19]. The comparison of simulation data to experiments is plotted in Fig. 2.

To model interstitial ejection during As deactivation, we include arsenic-assisted Frenkel pair generation in addition to bulk generation/recombination. Since *ab-initio* calculations described above find no additional barrier beyond that required for the I to diffuse away,
for I ejection reactions we simply reduce the normal Frenkel pair energy by the same binding energies that were found from comparison to equilibrium activation. Our analysis shows that dominant reaction for high concentration As deactivation is:

\((\text{As}_4\text{Si})^4^+ + 4e^- \rightarrow (\text{As}_4\text{V})^0 + I^0\). \hspace{1cm} (1)

The initial number of \(\text{As}_4\text{Si}\) complexes after ion implantation and regrowth is estimated based on random distribution of dopants and the corresponding occupational probabilities:

\[ C_{\text{As}_4\text{Si}} = C_{\text{Si}} \left(\frac{C_{\text{As}}}{C_{\text{Si}}}\right)^4 \left(1 - \frac{C_{\text{As}}}{C_{\text{Si}}}\right). \hspace{1cm} (2)\]

\(\text{As}_4\text{Si}\) complexes are assumed to be formed by AsI pair migration, again based on random reconfiguration as in KLMC simulations. The strong super-linear dependence of deactivation reaction on As concentration gives a sharp onset of deactivation as a function of As concentration. Since a large number of interstitials are released during As deactivation, a corresponding large interstitial supersaturation is present during the process. We used a moment-based \(\{311\}/\)loop model \cite{21} to account for extended defect formation.

3 COMPARISON TO EXPERIMENT

It has been observed in isothermal annealing experiments \cite{3}, that for high arsenic active concentration, initial deactivation is very rapid (within 15 seconds). After this rapid initial deactivation, activation level is similar for all doses, and activation continues but on much slower time scale. At lower temperature the deactivation kinetics are substantially slower but show the same basic behavior. Fig. 3 and Fig 4 shows comparison of our model to experimental data.

It has also been observed via buried B marker layers that deactivation of high concentration arsenic layers injects interstitials into the substrate \cite{5}. Initial rapid deactivation is due to interstitial ejection from As clusters which form due to random dopant motions. Figure 5 shows comparison of simulation results to experimental data of Rousseau for arsenic layers which were initially fully-activated via laser anneal.

4 CONCLUSIONS

We utilized a combination of ab-initio calculations (DFT), kinetic lattice Monte Carlo (KLMC) simulations and continuum modeling in order to gain understanding of arsenic diffusion and activation/deactivation. The results highlighted the importance of ejection of silicon atoms from arsenic clusters. The barrier for Frenkel pair generation is reduced by the strong binding of V to As clusters. These As clusters form via random interstitial-mediated diffusion. We find it is possible to account for both the very rapid initial deactivation of arsenic as well as the strongly superlinear dependence of interstitial supersaturation on doping level which accompanies deactivation.

5 ACKNOWLEDGEMENTS

This work was supported by the Semiconductor Research Corporation. Thanks to Marcie Berding, Jianjun
Xie and Shao-Ping Chen for discussion regarding their ab-initio calculations.

REFERENCES